

Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic				·
IGBT thermal resistance,	R _{thJC}		0.5	K/W
junction – case				
Thermal resistance,	R _{thJA}		40	
junction – ambient ¹⁾				

Electrical Characteristic, at T_j = 25 °C, unless otherwise specified

Parameter	Symbol Conditions	Value			Unit	
Parameter		Conditions	min.	Тур.	max.	
Static Characteristic						
Collector-emitter breakdown voltage	V _{(BR)CES}	$V_{\rm GE} = 0V, I_{\rm C} = 500 \mu A$	600	-	-	V
Collector-emitter saturation voltage	V _{CE(sat)}	$V_{\rm GE}$ = 15V, $I_{\rm C}$ =30A				
		T _j =25°C	1.7	2.1	2.4	
		<i>T</i> _j =150°C	-	2.5	3.0	
Gate-emitter threshold voltage	V _{GE(th)}	$I_{\rm C} = 700 \mu {\rm A}, V_{\rm CE} = V_{\rm GE}$	3	4	5	
Zero gate voltage collector current	I _{CES}	$V_{\rm CE}$ =600V, $V_{\rm GE}$ =0V				μA
		T _j =25°C	-	-	40	
		<i>T</i> _j =150°C	-	-	3000	
Gate-emitter leakage current	I _{GES}	$V_{\rm CE} = 0 V, V_{\rm GE} = 20 V$	-	-	100	nA
Transconductance	g fs	$V_{\rm CE}$ =20V, $I_{\rm C}$ =30A	-	20	-	S
Dynamic Characteristic						
Input capacitance	Ciss	V _{CE} =25V,	-	1600	1920	pF
Output capacitance	Coss	$V_{GE}=0V$,	-	150	180	
Reverse transfer capacitance	Crss	f=1MHz	-	92	110	
Gate charge	Q _{Gate}	V _{CC} =480V, <i>I</i> _C =30A	-	140	182	nC
		V _{GE} =15V				
Internal emitter inductance	LE		-	7	-	nH
measured 5mm (0.197 in.) from case						
Short circuit collector current ²⁾	I _{C(SC)}	V_{GE} =15V, t_{SC} ≤10µs V_{CC} ≤ 600V, T_{j} ≤ 150°C	-	300	-	A

¹⁾ Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70μm thick) copper area for collector connection. PCB is vertical without blown air.
²⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.



Switching Characteristic, Inductive Load, at Tj=25 °C

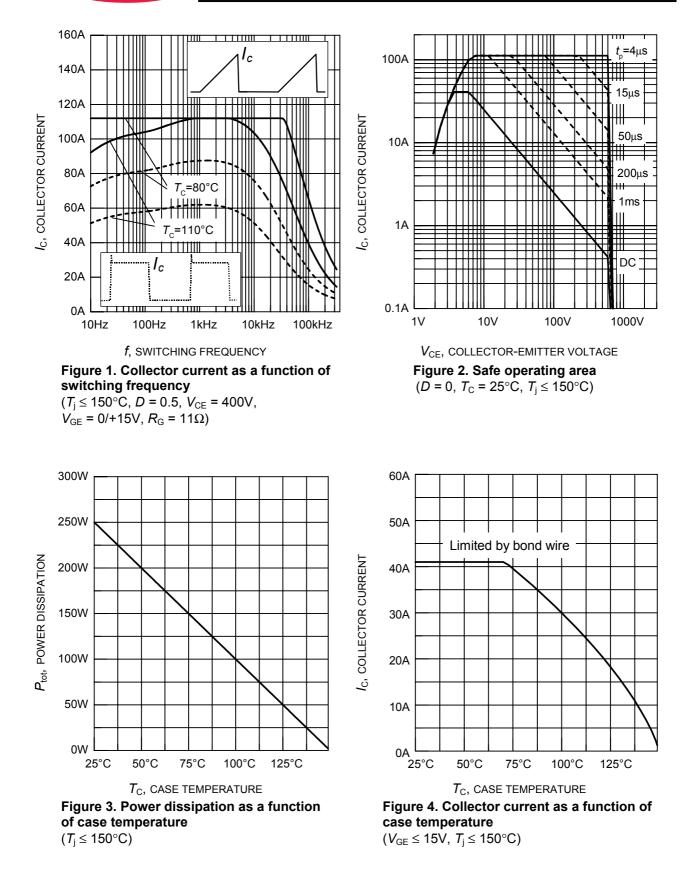
Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
IGBT Characteristic						
Turn-on delay time	t _{d(on)}	$T_{j}=25^{\circ}C,$ $V_{CC}=400V, I_{C}=30A,$ $V_{GE}=0/15V,$ $R_{G}=11\Omega,$ $L_{\sigma}^{(1)}=180nH,$ $C_{\sigma}^{(1)}=900pF$ Energy losses include	-	44	53	ns
Rise time	t _r		-	34	40	
Turn-off delay time	$t_{d(off)}$		-	291	349	
Fall time	t _f		-	58	70	
Turn-on energy	Eon		-	0.64	0.77	mJ
Turn-off energy	E _{off}	"tail" and diode	-	0.65	0.85	
Total switching energy	E _{ts}	reverse recovery.	-	1.29	1.62	1

Switching Characteristic, Inductive Load, at T_j=150 °C

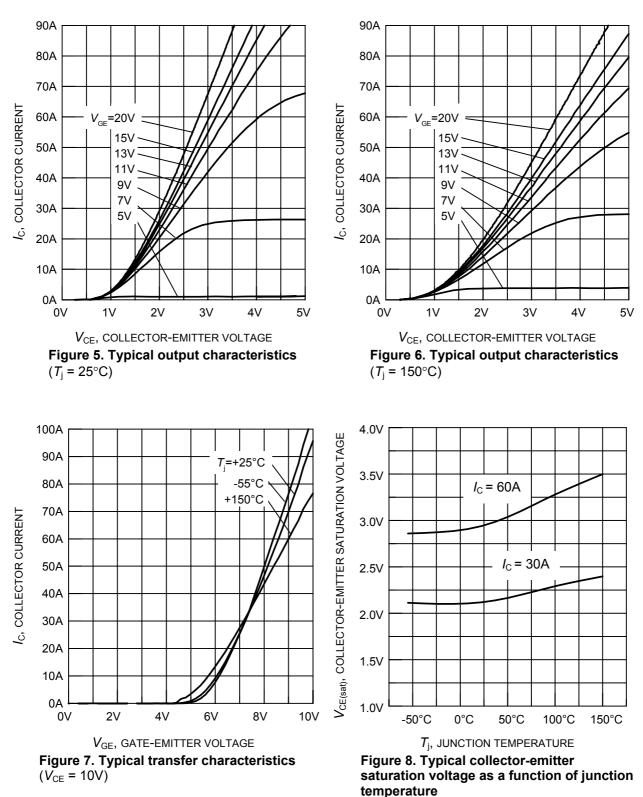
Parameter	Symbol	Conditions	Value			11
			min.	typ.	max.	Unit
IGBT Characteristic						
Turn-on delay time	t _{d(on)}	$T_{j}=150^{\circ}C$ $V_{CC}=400V, I_{C}=30A,$ $V_{GE}=0/15V,$ $R_{G}=11\Omega,$ $L_{\sigma}^{(1)}=180nH,$ $C_{\sigma}^{(1)}=900pF$ Energy losses include	-	44	53	ns
Rise time	tr		-	34	40	
Turn-off delay time	$t_{d(off)}$		-	324	389	
Fall time	t _f		-	67	80	
Turn-on energy	Eon		-	0.98	1.18	mJ
Turn-off energy	E _{off}	"tail" and diode	-	0.92	1.19	
Total switching energy	Ets	reverse recovery.	-	1.90	2.38	

 $^{1)}$ Leakage inductance L_{σ} and Stray capacity C_{σ} due to dynamic test circuit in Figure E.



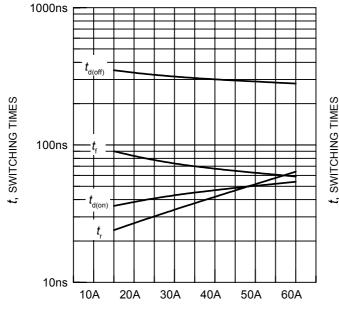






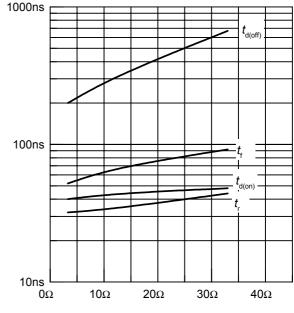
 $(V_{\rm GE} = 15V)$





 $I_{\rm C}$, COLLECTOR CURRENT

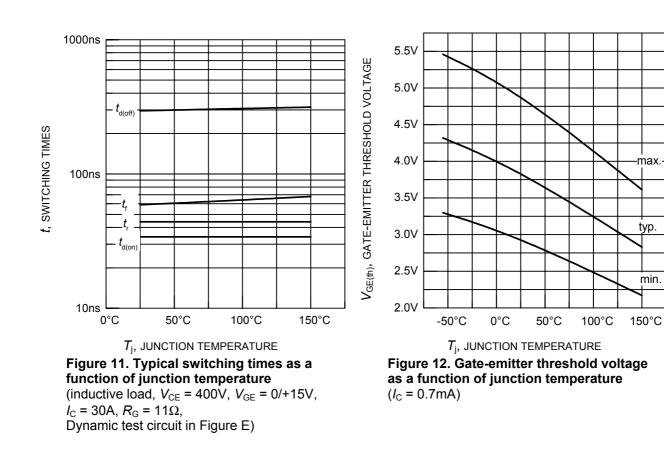
Figure 9. Typical switching times as a function of collector current (inductive load, $T_j = 150$ °C, $V_{CE} = 400$ V, $V_{GE} = 0/+15$ V, $R_G = 11\Omega$, Dynamic test circuit in Figure E)



 $R_{\rm G}$, gate resistor

Figure 10. Typical switching times as a function of gate resistor (inductive load, $T_j = 150^{\circ}$ C, $V_{CE} = 400$ V, $V_{GE} = 0/+15$ V, $I_C = 30$ A,

Dynamic test circuit in Figure E)



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5.0mJ *) Eon and Ets include losses E_{ts}^{*} 4.5mJ due to diode recovery. 4.0mJ SWITCHING ENERGY LOSSES 3.5mJ 3.0mJ E_{on}* 2.5mJ $E_{\rm off}$ 2.0mJ 1.5mJ шî 1.0mJ 0.5mJ 0.0mJ 60A 10A 20A 30A 40A 50A 70A $I_{\rm C}$, COLLECTOR CURRENT

Figure 13. Typical switching energy losses as a function of collector current (inductive load, $T_j = 150$ °C, $V_{CE} = 400$ V, $V_{GE} = 0/+15$ V, $R_G = 11\Omega$, Dynamic test circuit in Figure E)

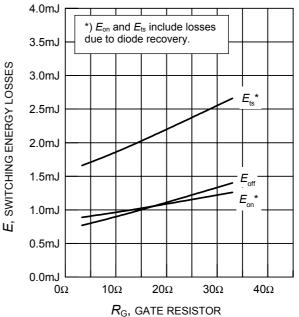


Figure 14. Typical switching energy losses as a function of gate resistor (inductive load, $T_j = 150^{\circ}$ C, $V_{CE} = 400$ V, $V_{GE} = 0/+15$ V, $I_C = 30$ A, Dynamic test circuit in Figure E)

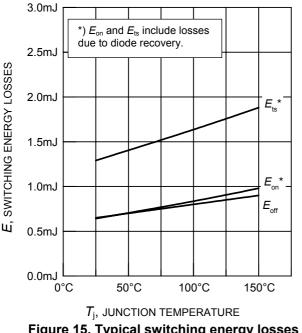
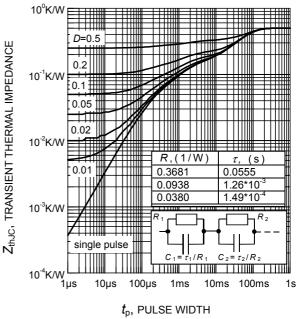
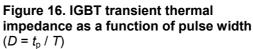
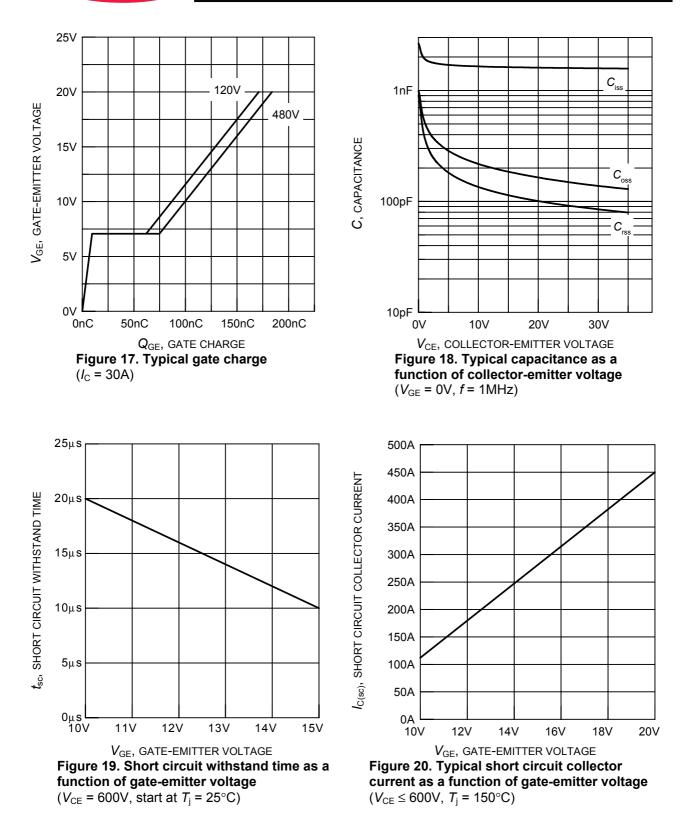


Figure 15. Typical switching energy losses as a function of junction temperature (inductive load, V_{CE} = 400V, V_{GE} = 0/+15V, I_C = 30A, R_G = 11 Ω , Dynamic test circuit in Figure E)

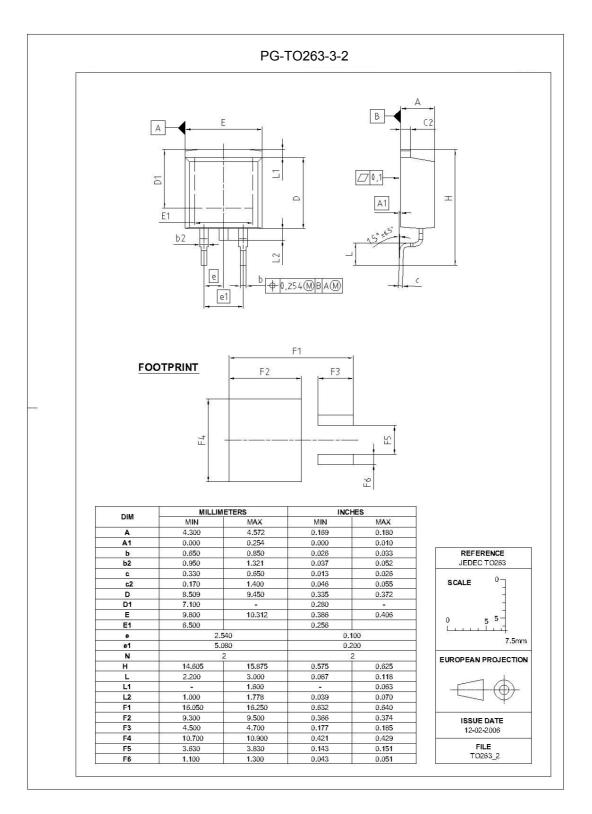














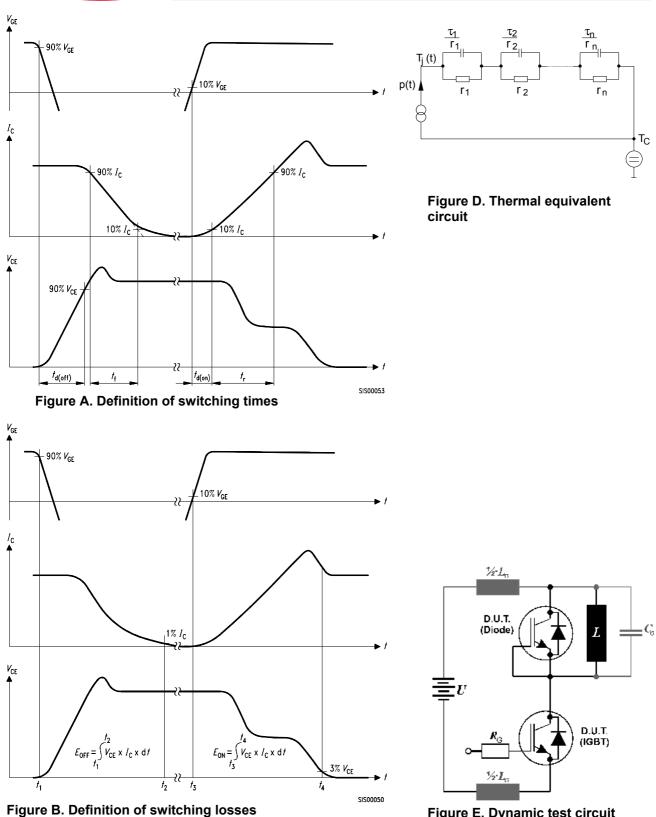


Figure E. Dynamic test circuit Leakage inductance L_{σ} =180nH and Stray capacity C_{σ} =900pF.

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